

OptoTEC™ OT Series Thermoelectric Cooler

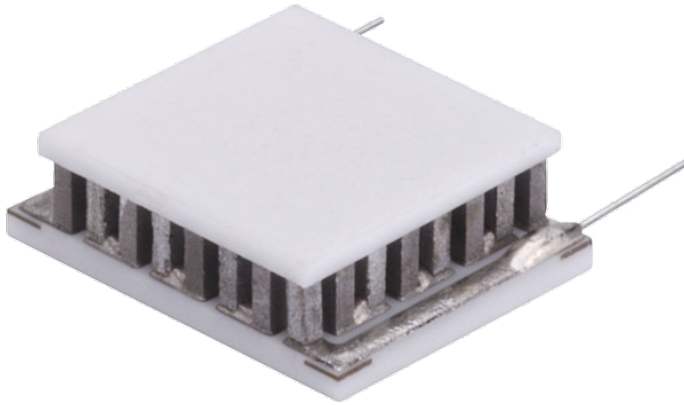
Note: This product is not recommended for new designs.

This product series has been replaced with the OptoTEC™ OTX Series.

The recommended replacement is:

MFG Part Number: 387006797

Description: OTX08-32-F0-0707-11-EP-W2.25

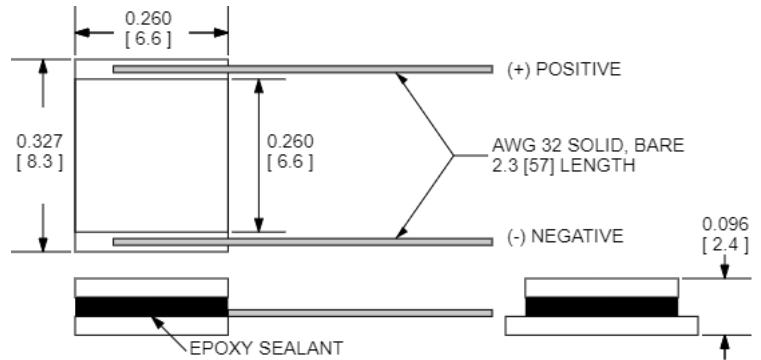


Features

- Miniature geometric sizes
- Precise temperature control
- Reliable solid-state operation
- No sound or vibration
- DC operation
- RoHS-compliant

Applications

- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems
- Heads-Up Displays, Imaging Sensors



CERAMIC MATERIAL: Al_2O_3

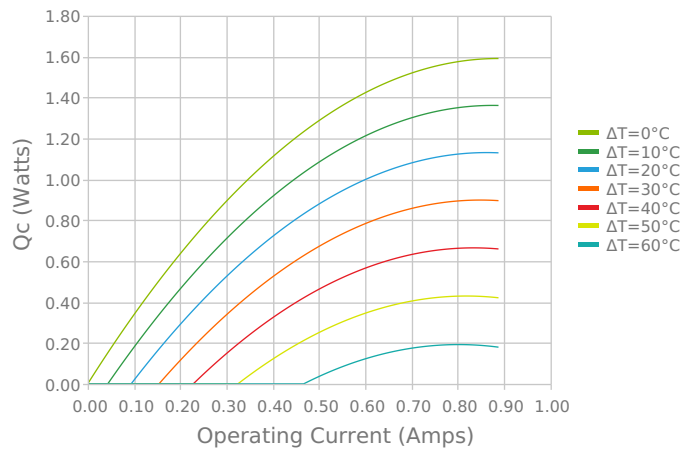
SOLDER CONSTRUCTION: 138°C, BiSn

INCHES [MM]

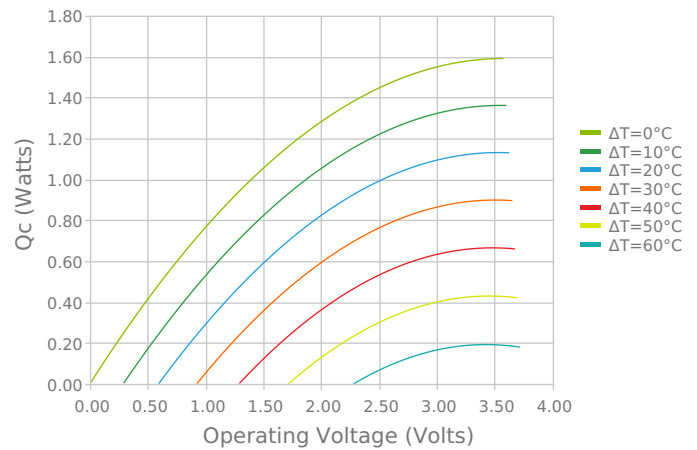
Note: Allow 0.020 in [0.5 mm] around perimeter of the thermoelectric cooler and lead wire attachment to accommodate sealant

ELECTRICAL AND THERMAL PERFORMANCE

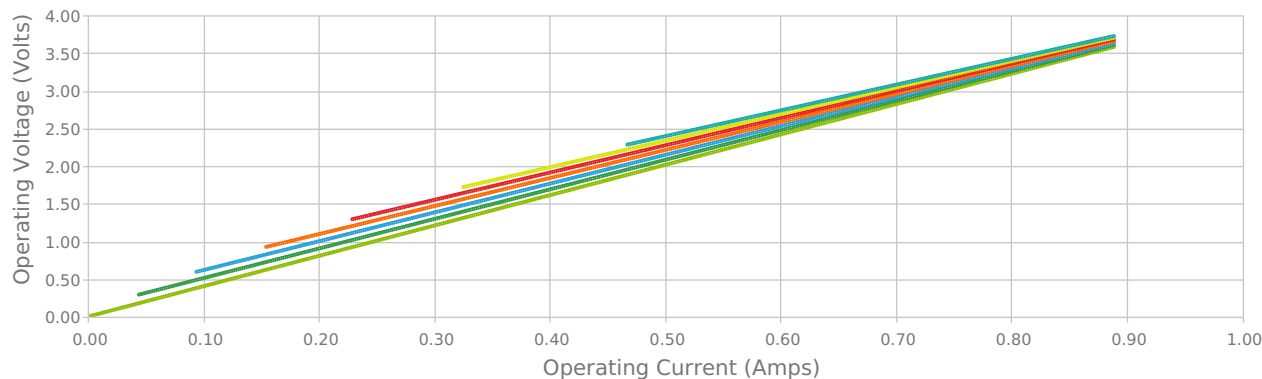
Heat Pumped at Cold Side
 $T_{\text{hot}} = 27^\circ\text{C}$



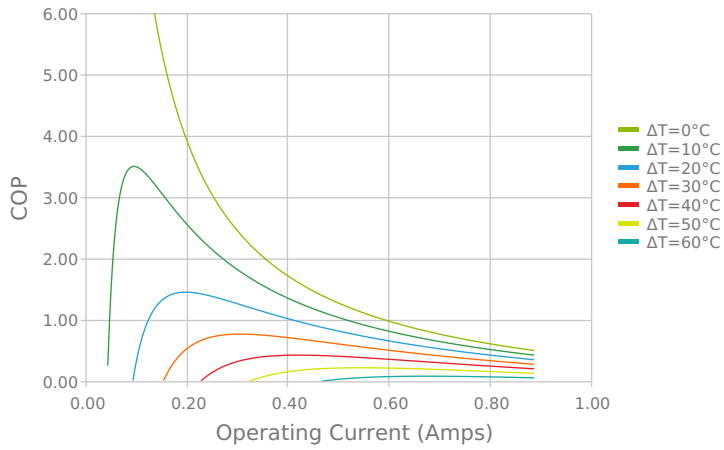
Heat Pumped at Cold Side
 $T_{\text{hot}} = 27^\circ\text{C}$



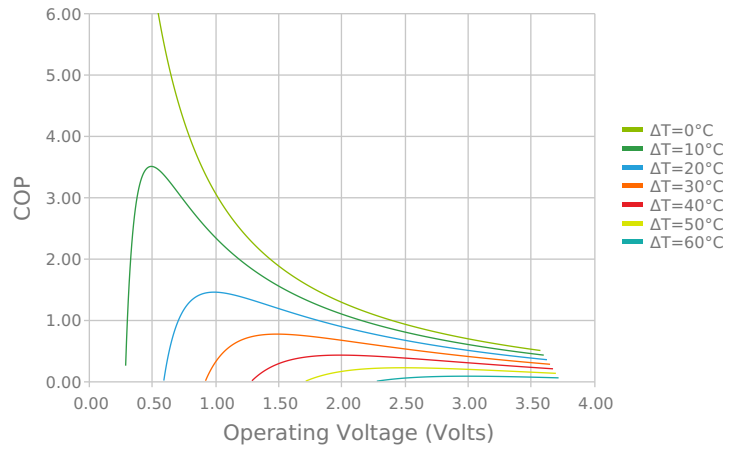
Current vs Voltage (I vs V)
 $T_{\text{hot}} = 27^\circ\text{C}$



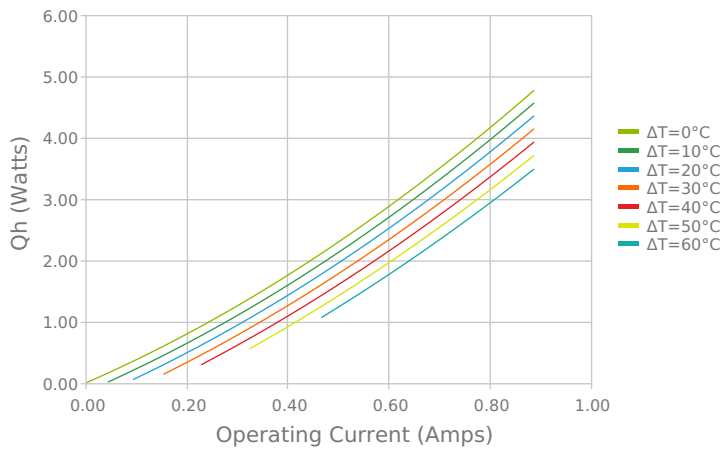
Coefficient of Performance (COP = Q_c/P_{in})
Thot = 27 °C



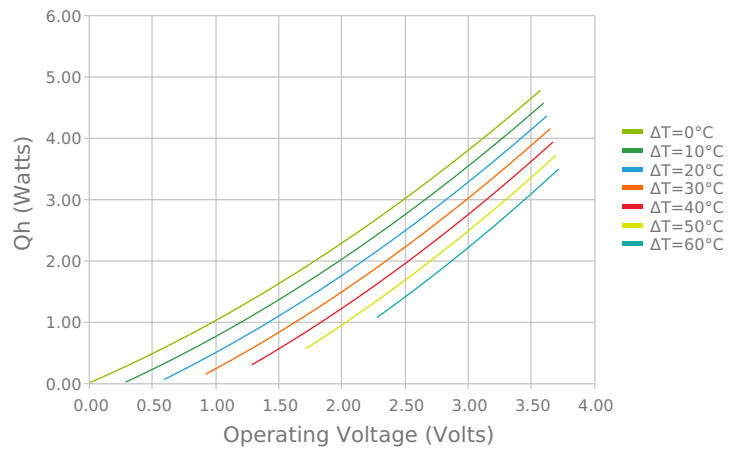
Coefficient of Performance (COP = Q_c/P_{in})
Thot = 27 °C



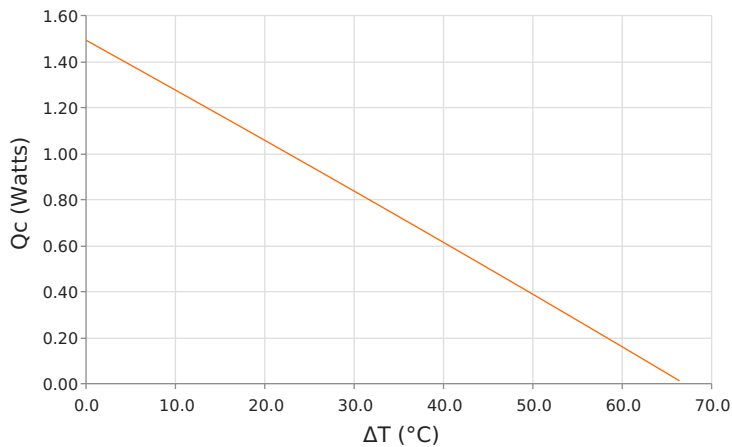
Total Heat Dissipated at Hot Side ($Q_h = Q_c + P_{in}$)
Thot = 27 °C



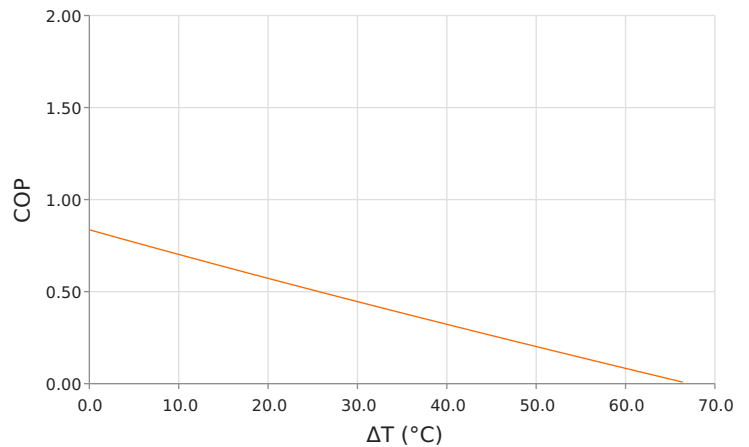
Total Heat Dissipated at Hot Side ($Q_h = Q_c + P_{in}$)
Thot = 27 °C



Heat Pumped at Cold Side (Q_c)
Thot = 27 °C | Current = 0.7 Amps



Coefficient of Performance (COP = Q_c/P_{in})
Thot = 27 °C | Current = 0.7 Amps



SPECIFICATIONS*

Hot Side Temperature

Qcmax ($\Delta T = 0$)

ΔT_{max} ($Q_c = 0$)

I_{max} (I @ ΔT_{max})

V_{max} (V @ ΔT_{max})

Module Resistance

Max Operating Temperature

Weight

	27.0 °C	35.0 °C	50.0 °C
Qcmax ($\Delta T = 0$)	1.6 Watts	1.6 Watts	1.7 Watts
ΔT_{max} ($Q_c = 0$)	68.0°C	70.9°C	76.0°C
I _{max} (I @ ΔT_{max})	0.8 Amps	0.8 Amps	0.8 Amps
V _{max} (V @ ΔT_{max})	3.4 Volts	3.5 Volts	3.8 Volts
Module Resistance	4.03 Ohms	4.19 Ohms	4.51 Ohms
Max Operating Temperature	80 °C		
Weight	1.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
11	2.438 ±0.127 mm 0.096 ± 0.0050 in	0.051 mm / 0.051 mm 0.002 in / 0.002 in	Lapped	Lapped	50.8 mm 2.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
EP	Epoxy	Black	-55 to 150°C	Low density syntactic foam epoxy encapsulant

NOTES

1. Max operating temperature: 80°C
2. Do not exceed I_{max} or V_{max} when operating module
3. Reference assembly guidelines for recommended installation
4. Solder tinning also available on metallized ceramics

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